

A Main Entrance, 3rd Street, Registration and Event HQ

B Chestnut Street Entrance

C 1st Floor Shell Space

- Engineering Challenge Workspace
- Lunch and Dinner Overflow
- Evening Beverage Service
- Wednesday Evening Entertainment

D Lab 211C

- Robotics with Phillips and the HU Robotics Team
- Augmented and Virtual Reality with the HU XR Taskforce, Sponsored by Deloitte

E Breakout Rooms 210B and 210C are available if you need a place for a sidebar meeting

F 2nd Floor Auditorium

- Monday: Army AdvM CoP Annual Meeting
- Tuesday: “Kick Ass Conversation” on Expeditionary Manufacturing, hosted by The Barnes Global Advisors
- Wednesday: Additive Manufacturing of Electronics Roundtable, Led by APES
- Thursday: Critical Materials for National Security, hosted by Critical Materials America

G Lab 216, Makerspace

- Jason Lopes and Gentle Giant Studios
- MatterHackers

Floor 3

Floor 2M

Floor 2

Floor 1

H Lab 223, Industrial Applications

- Phillips Hybrid and CNC Manufacturing
- ARIS Technology, 3D Scanning / Digital Twin
- IC3D Industrial FFF
- SMRT, Machine Dynamics for CNC Machining
- Novineer, Generative Design for Hybrid / CNC

I Lab 2M.01, Additive Manufacturing of Electronics

- Advanced Printed Electronic Solutions
- Hummink
- NanoDimension
- nScript
- XTPL

Lab 2M.06, Characterization

- Hyphen Innovations, High Speed Fatigue Testing

J 3rd Floor Lounge Area

- DfAM Demo by Vixiv

K Lab 315C, Sponsor Expo and Student Poster Session, Sponsored by Phillips

L Labs 305 and 306

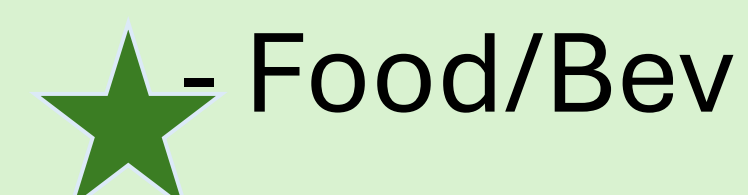
- Smart Factory Assembly Line
- CAD and CAM Lab

M Outside of Lab 329

- Get Your Head Scanned, 3D Scanning Demo by Cimquest

N Lab 329, Additive Manufacturing

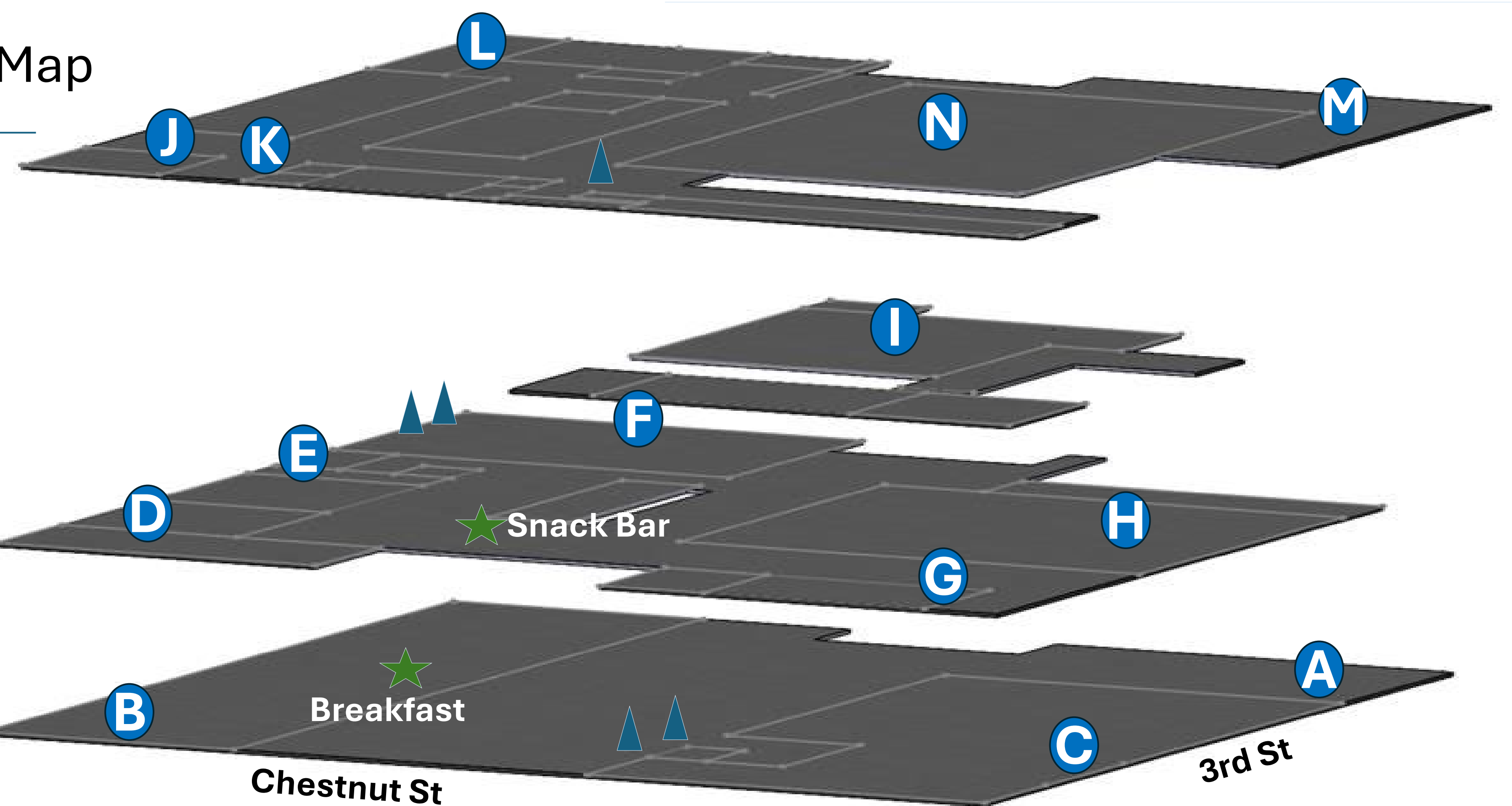
- Axtra3D, AM for Injection Molding
- Cimquest, Fuse 1 SLS
- KVG, AM for Global Logistics
- Novineer, Generative Design for AM
- Phillips and EOS, P110 SLS
- Stratasys, Industrial FFF
- Xact Metal, Affordable DMLS

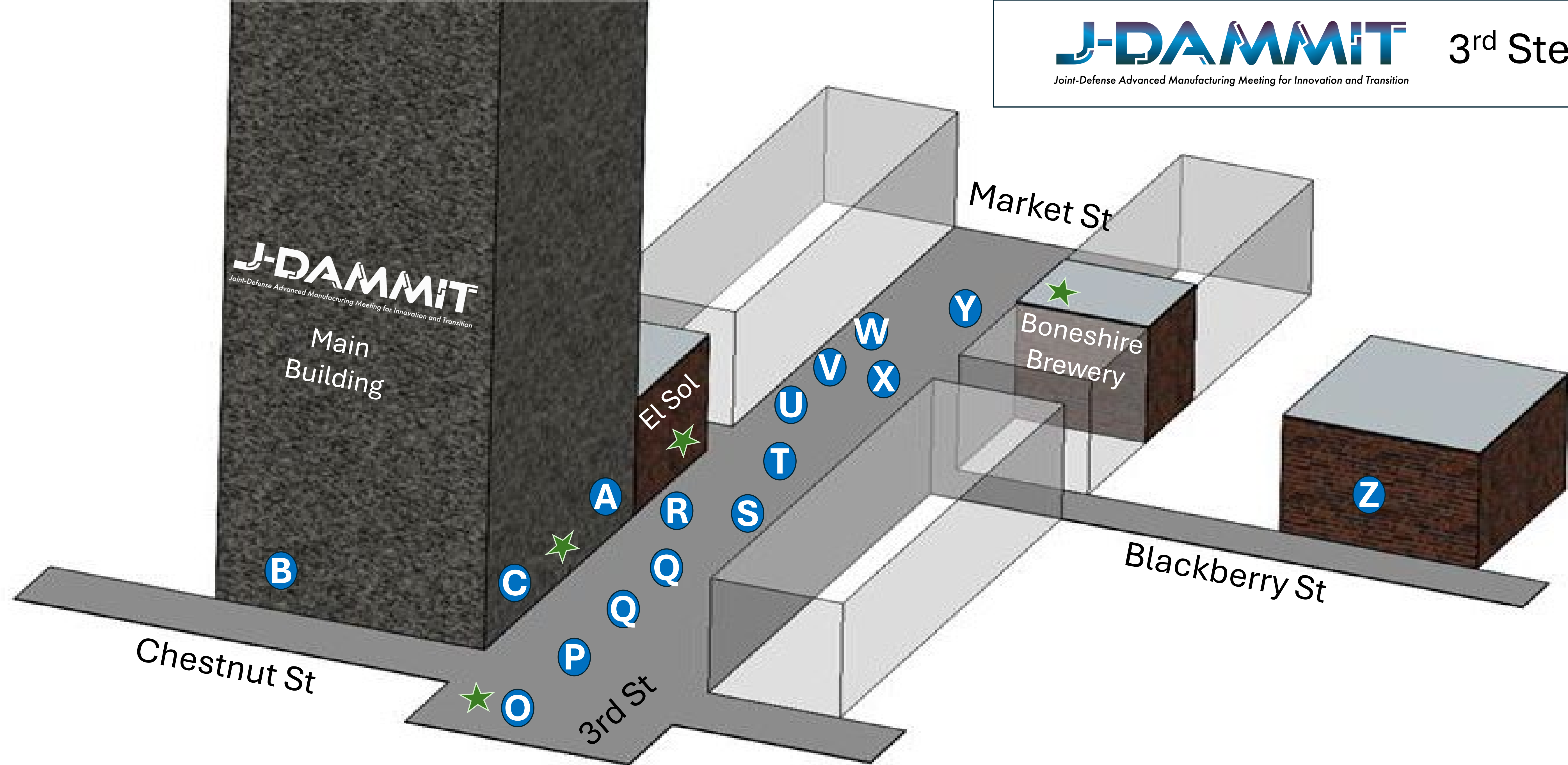


- Food/Bev



- Restrooms





- O** Food Truck Parking
- P** 3rd Street Stage
- Q** Tents and Outdoor Seating
- R** Expeditionary Composite Additive Manufacturing by FIELDMADE
- S** Phillips Expeditionary System with Hybrid Manufacturing Capabilities
- T** C2 Configurable Expeditionary Platform, Presented by AES2
- U** Portable Cold Spray by Titomic

★ - Food/Bev

- V** Snowbird Technologies will be Demonstrating their Additive Mobile Manufacturing Technology
- W** Earlbeck Gasses and Technologies will Teach Attendees Several Welding Techniques
- X** Additive Manufacturing Evaporative Casting by Skuld; Pour Some Aluminum!
- Y** Experience Stratasys Tour Truck will have Several Industrial Printers on Display
- Z** HAMR Industries and SPEE3D Demonstrate Cold Spray Additive Manufacturing in the Blackberry Technology Building